



Application of

: David R. Hembree et al.

Applicants Serial No.

: 09/206,080

Filed Title : February 19, 1998 : A SPRING ELEMENT FOR USE IN AN

APPARATUS FOR ATTACHING TO A

SEMICONDUCTOR AND A METHOD

OF ATTACHING

Docket No.

: MIO 0020 IA : Roy Potter

Examiner Art Unit

: 2822

Box Non-Fee Amendment

Assistant Commissioner for Patents

Washington, D.C. 20231

Sir:

TECHNOLOGY CENTER 2800

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Box Now-Fee Amendment, Assistant Commissioner for Patents, Washington, D.C. 20231, on January 25, 2021

eed

Reg. No.

AMENDMENT UNDER 37 CFR §1.111

This paper is being filed in response to the Office Action mailed November 22, 2000, having a reply due date of February 22, 2001. Reconsideration of the present application is respectfully requested in light of the amendments and remarks below.

IN THE CLAIMS

21. (Amended) A spring element comprising a plurality of <u>elastomeric threads</u> interwoven <u>with</u> [and a] conductive <u>threads</u> [member].

Please cancel claims 22-24.

Please add the following new claim:

74. A spring element according to claim 21, further comprising a layer of conductive material formed over an elastic member.

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